



## 20V N-Channel Enhancement Mode MOSFET

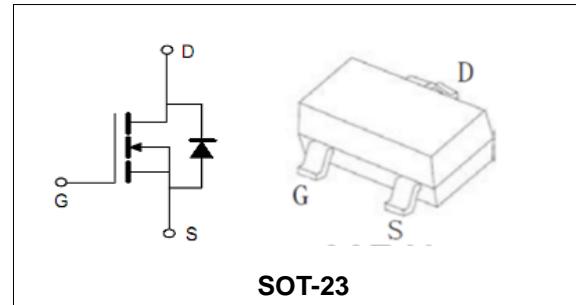
**Features**

- Advanced trench process technology
- High Density Cell Design For Ultra Low On-Resistance
- High Power and Current handing capability

BVDSS	20	V
ID	4	A
RDS(on)@VGS=4.5V	27	mΩ
RDS(on)@VGS=2.5V	35	mΩ

**Applications**

- Low Side Load Switch
- Battery Switch
- Optimized for Power Management Applications for Portable Products, such as Aeromodelling, Power bank, Brushless motor, Main board , and Others

**Order Information**

Product	Package	Marking	Reel Size	Reel	Carton
PT2302D	SOT-23	A2sHB	7inch	3000PCS	180000PCS

**Absolute Maximum Ratings**

Symbol	Parameter	Rating	Unit	
<b>Common Ratings (TC=25°C Unless Otherwise Noted)</b>				
V <sub>(BR)DSS</sub>	Drain-Source Breakdown Voltage	20	V	
V <sub>GS</sub>	Gate-Source Voltage	±10	V	
T <sub>J</sub>	Maximum Junction Temperature	150	°C	
T <sub>STG</sub>	Storage Temperature Range	-55 to 150	°C	
I <sub>S</sub>	Diode Continuous Forward Current	TA =25°C	1.6	A
<b>Mounted on Large Heat Sink</b>				
I <sub>DM</sub>	Pulse Drain Current Tested (Silicon Limit) (Note1)	TA =25°C	12	A
I <sub>D</sub>	Continuous Drain current	TA =25°C	4	A
P <sub>D</sub>	Maximum Power Dissipation	TA =25°C	1.25	W
R <sub>θJA</sub>	Thermal Resistance Junction-to-Ambient (Note2)		100	°C/W

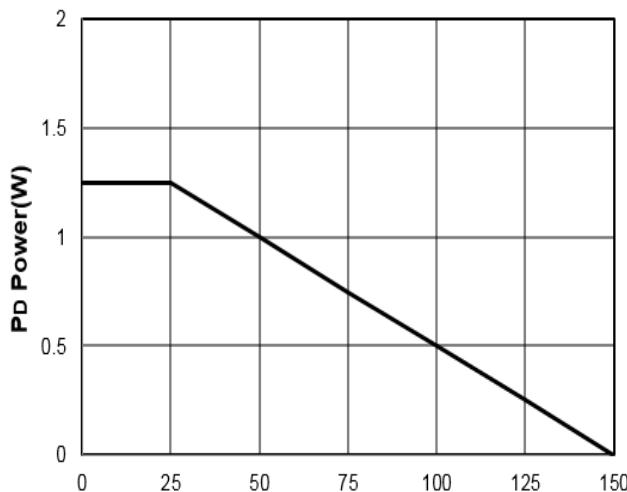
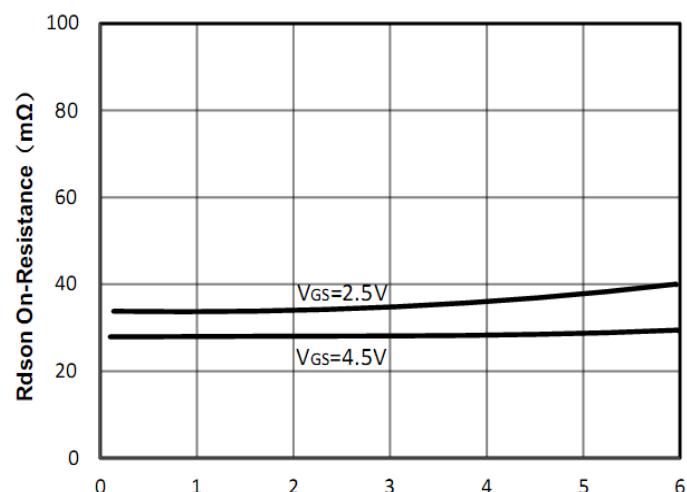
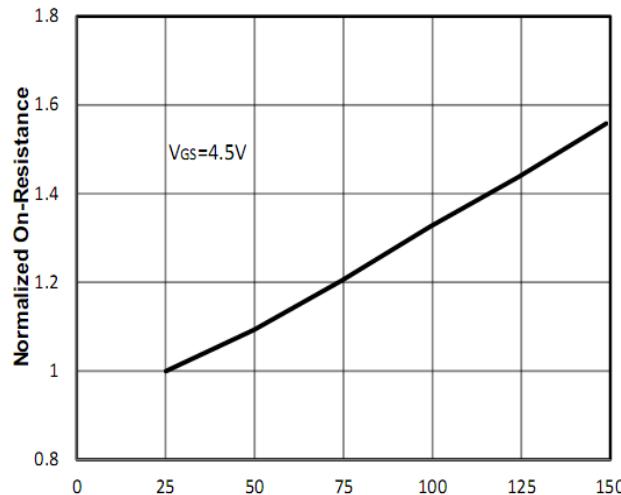
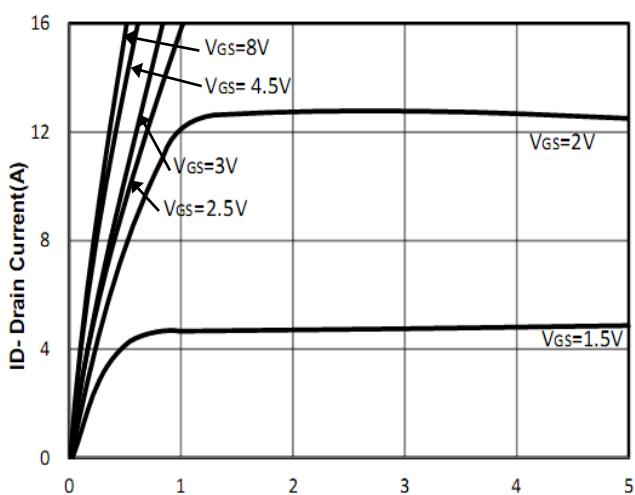
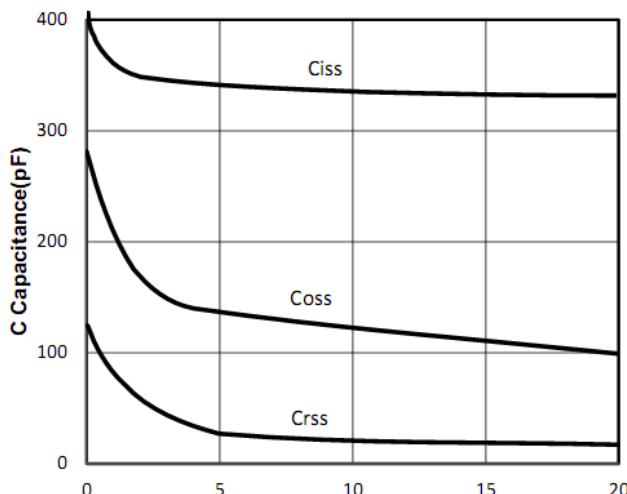
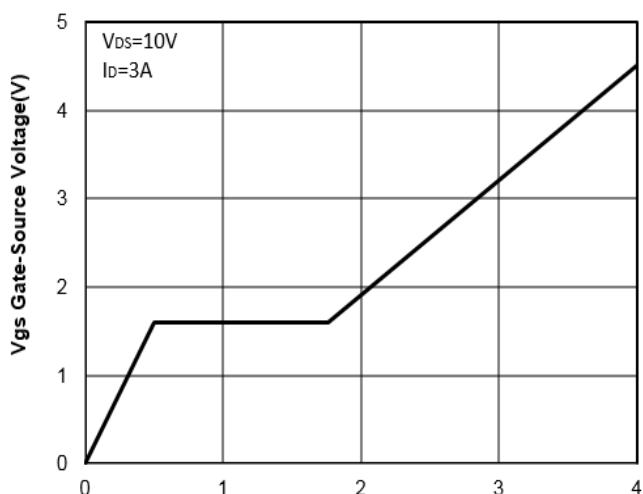


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Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
<b>Static Electrical Characteristics @ TJ = 25°C (unless otherwise stated)</b>						
$V_{(BR)DSS}$	Drain- Source Breakdown Voltage	$VGS=0V$ $ID=250\mu A$	20	--	--	V
$I_{DSS}$	Zero Gate Voltage Drain current	$VDS=16V$ , $VGS=0V$	--	--	1	$\mu A$
$I_{GSS}$	Gate-Body Leakage Current	$VGS=\pm 10V$ , $VDS=0V$	--	--	$\pm 100$	nA
$V_{GS(TH)}$	Gate Threshold Voltage	$VDS=VGS$ , $ID=250\mu A$	0.52	--	1.2	V
$R_{DS(ON)}$	Drain-Source On-State Resistance (Note3)	$VGS=4.5V$ , $ID=4A$	--	27	40	$m\Omega$
		$VGS=2.5V$ , $ID=3.5A$	--	35	45	$m\Omega$
<b>Dynamic Electrical Characteristics @ TJ = 25°C (unless otherwise stated) (Note4)</b>						
$C_{iss}$	Input Capacitance	$VDS= 10V$ , $VGS=0V$ , $F=1MHz$	--	340	--	pF
$C_{oss}$	Output Capacitance		--	115	--	pF
$C_{rss}$	Reverse Transfer Capacitance		--	33	--	pF
$Q_g$	Total Gate Charge	$VDS= 10V$ , $ID= 3A$ ,	--	5.4	--	nC
$Q_{gs}$	Gate-Source Charge		--	0.65	--	nC
$Q_{gd}$	Gate-Drain Charge		--	1.6	--	nC
<b>Switching Characteristics (Note4)</b>						
$t_{d(on)}$	Turn-on Delay Time	$VDD=10V$ , $RL=5.5\Omega$ , $RG=6\Omega$ , $VGS=4.5V$	--	12	--	nS
$t_r$	Turn-on Rise Time		--	36	--	nS
$t_{d(off)}$	Turn-off Delay Time		--	34	--	nS
$t_f$	Turn-off Fall Time		--	10	--	nS
<b>Source- Drain Diode Characteristics@ TJ = 25°C (unless otherwise stated)</b>						
$V_{SD}$	Forward on voltage (Note3)	$IS=1A$ , $VGS=0V$	--	--	1.2	V

Note:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board,  $t \leq 10$  sec
3. Pulse Test: pulse width  $\leq 300$  us, duty cycle  $\leq 2\%$ .
4. Guaranteed by design, not subject to production testing.

**20V N-Channel Enhancement Mode MOSFET**
**Typical Characteristics**

**Figure1: TJ Junction Temperature (°C)**

**Figure2: ID Drain Current (A)**

**Figure3: TJ Junction Temperature (°C)**

**Figure4: V<sub>DS</sub> Drain-Source Voltage (V)**

**Figure5: V<sub>DS</sub> Drain-Source Voltage (V)**

**Figure6: Q<sub>g</sub> Gate Charge (nC)**

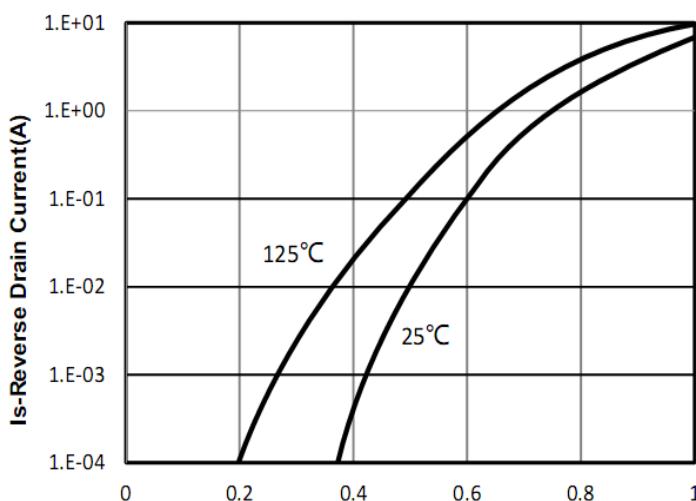
**20V N-Channel Enhancement Mode MOSFET**


Figure 7: V<sub>sd</sub> Source-Drain Voltage (V)

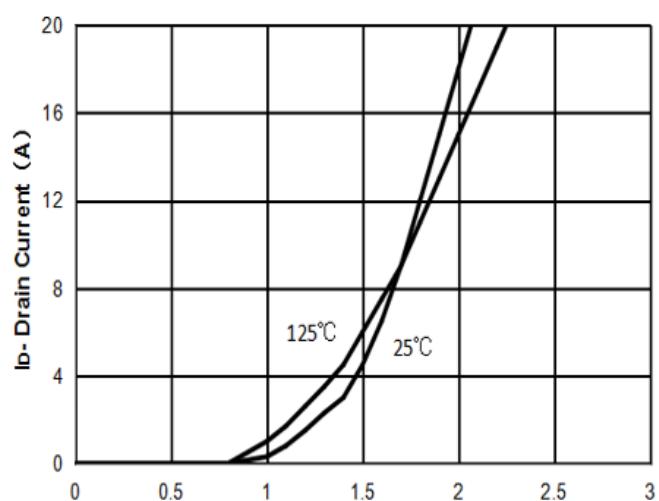


Figure 8: V<sub>gs</sub> Gate-Source Voltage (V)

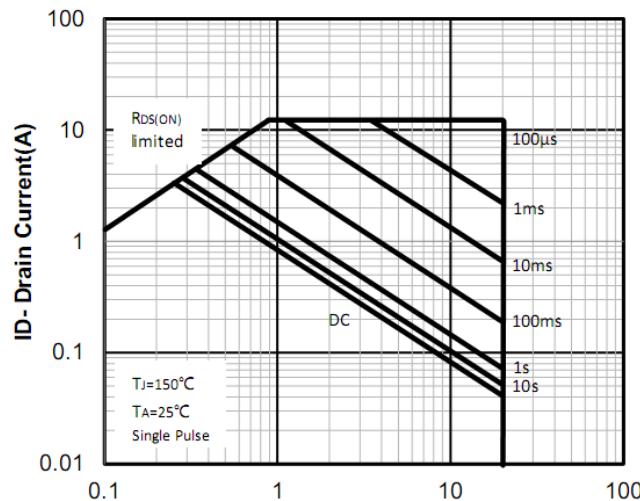


Figure 9: V<sub>ds</sub> Drain-Source Voltage (V)

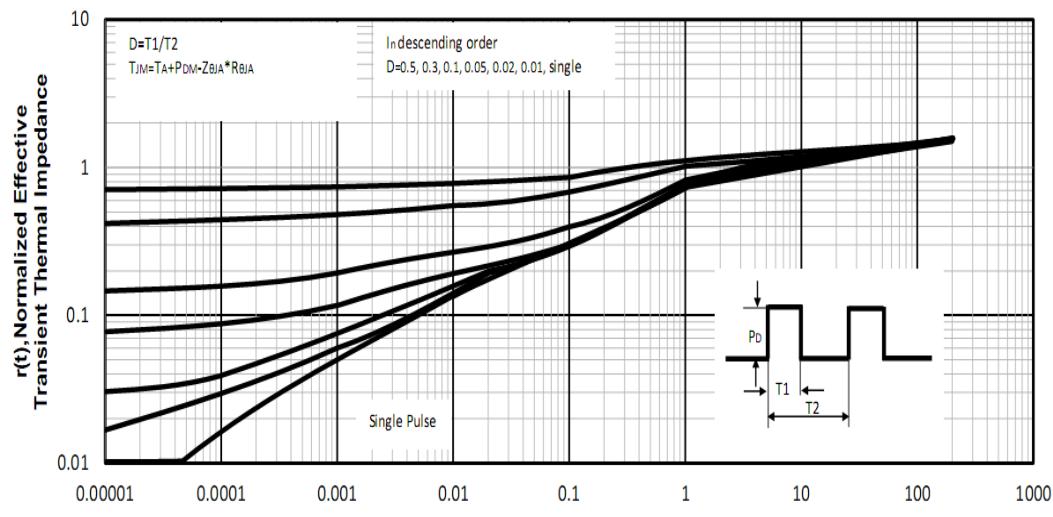
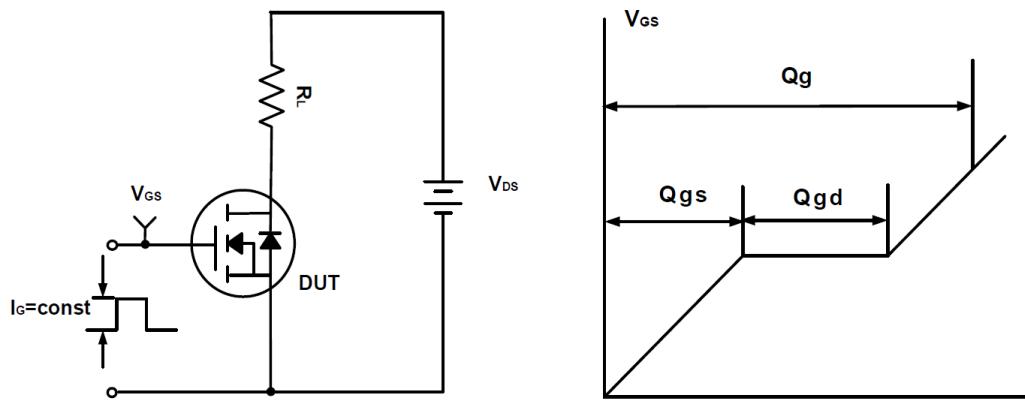
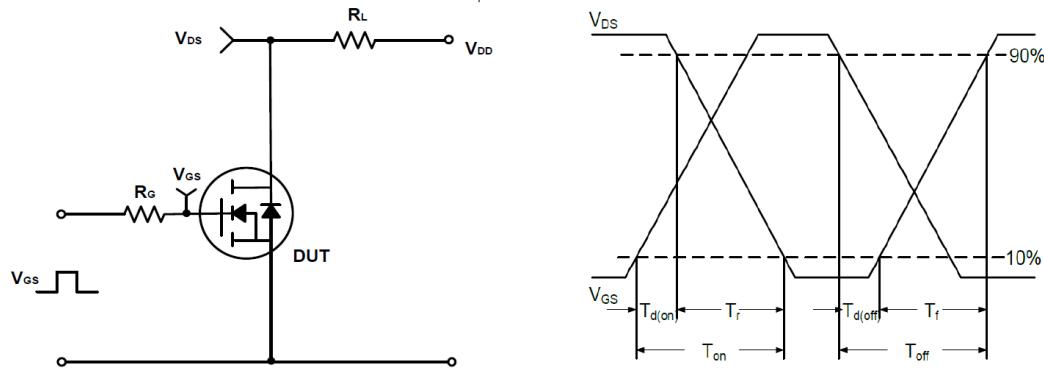
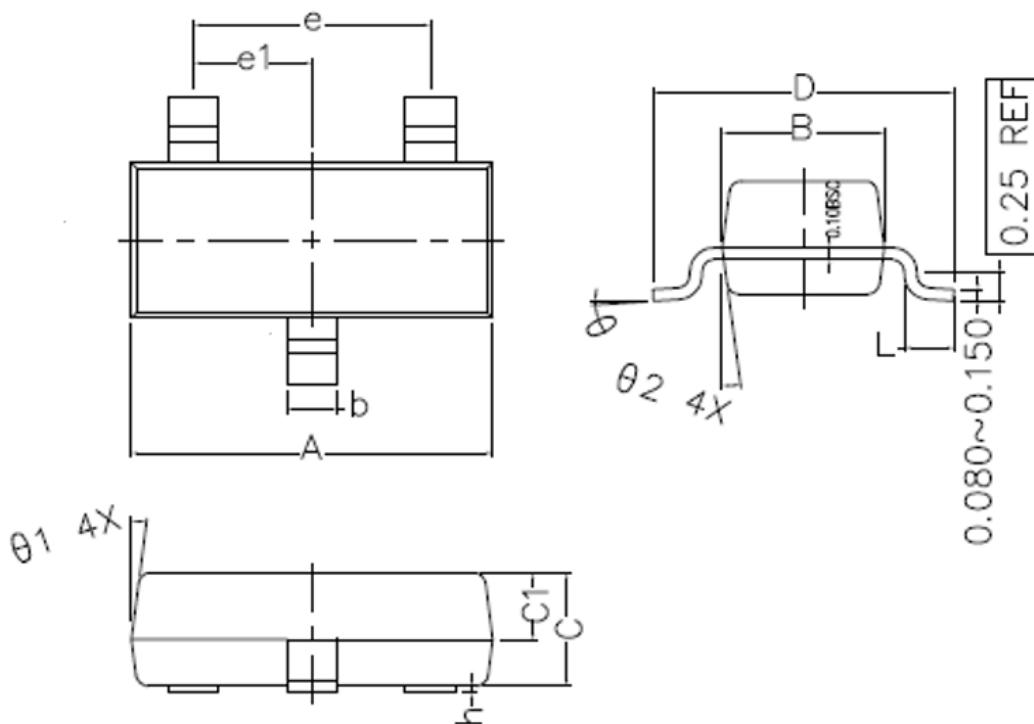


Figure 10: Square Wave Pulse Duration (sec)

**20V N-Channel Enhancement Mode MOSFET**
**Test Circuit and Waveform:**

**Figure A Gate Charge Test Circuit & Waveforms**

**Figure B Switching Test Circuit & Waveforms**

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**SOT-23 Package Outline Dimensions (Units: mm)**


COMMON DIMENSIONS (UNITS OF MEASURE IS mm)			
	MIN	NORMAL	MAX
A	2.800	2.900	3.000
B	1.200	1.300	1.400
C	0.900	1.000	1.100
C1	0.500	0.550	0.600
D	2.250	2.400	2.550
L	0.300	0.400	0.500
h	0.010	0.050	0.100
b	0.300	0.400	0.500
e	1.90 TYPE		
e1	0.95 TYPE		
θ <sub>1</sub>	7° TYPE		
θ <sub>2</sub>	7° TYPE		
θ	0° ~ 7°		